

PackPlus

Connecting you to the future of packaging

POST SHOW REPORT 2019









PackPlus 2019 FACTS & FIGURES

PackPlus was successfully held on 29-31 August 2019 at Pragati Maidan, New Delhi, India. The show recorded a huge success with 393 exhibitors and a footfall of 20,849 Visitors.



19000

sq mtrs



20849

Visitors



393

Exhibitors



187

first-time exhibitors



981

VIP buyers









OPENING CEREMONY

PackPlus 2019 was inaugurated at the hands of Mr. Vinod Rajpal, Zhongke India, Mr. Naman Singhal, MD, Global Link Impex and Mr. Anil Arora, President, Print-Packaging.com. The other dignitaries Mr. Gregory Zaraisky, CEO, Reed Exhibitions India, Mr. Anuj Mathur, COO, Reed Exhibitions India, Mr. Prateek Kaushik, Project Director (PackPlus), Next Events Pvt Ltd (A member of Reed Exhibitions & a part of RELX Group) were also present.





BRINGING THE ENTIRE VALUE CHAIN OF PACKAGING



CartonTech - showcases the next-gen technologies from the industry players across various categories like pre-production & pre-press systems and equipment, Folding carton equipment & accessories, Rigid box converting equipment, gluing machines, erecting machines, paper bag manufacturing equipment Films & Foils, Paper & cartonboard, Inks, Adhesives, Printing equipment and much more.

India Converting Show- showcases generation next technologies from worldwide solution providers across various categories like pre-press, in-press and converting equipment. The Show will host dedicated pavilions for package designers & converters coating-laminating & finishing equipment, inks anilox rollers, wide & narrow web printing flexo presses and equipment, plates & plate making equipment, die cutting tools, accessories, material suppliers & many more will widely be displayed at the event.





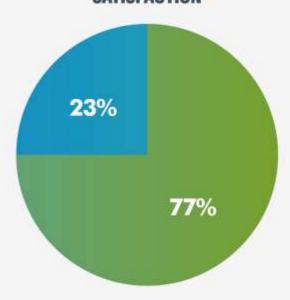
PackSol- the exclusive Finished Packaging Segment at PackPlus offers Opportunities to Manufacturers of Packaging Solutions in Flexible Packaging, Cartons, Paper, Plastics, Glass, Metals and other formats. The segment will showcase latest innovations in Finished, Luxury and Specialised Packaging Solutions for Brand owners and Packaging Buyers.

SupplyPlus is logistics, warehousing and distribution show for end-of-line packaging solutions. It showcases the latest technologies in AIDC like Barcodes, Biometrics, Radio Frequency Identification (RFID), Smart Cards, Electronic Articles Surveillance (EAS), Real Time Locating Systems (RTLS), Mobile Computing, Wireless & Networking Solutions etc. From Logistics: Supply Chain system designers & integrators, cold chain, sorting, grading, cleaning, warehousing systems, material handling, weighing, testing equipment, software, backend support and other services.



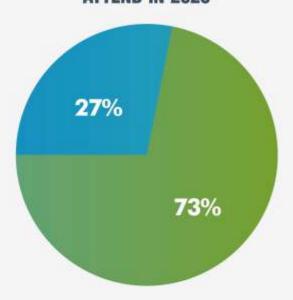
HAPPY EXHIBITORS MEANS REAL SUCCESS!

EXHIBITORS LEVEL OF SATISFACTION



Most of the exhibitors were satisfied with overall visitor footfall and arrangements.

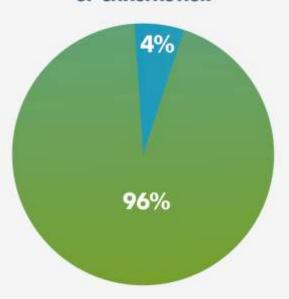
EXHIBITORS LIKELINESS TO ATTEND IN 2020



Majority if the exhibitors have show interest to exhibit at the next edition of PackPlus in 2020.

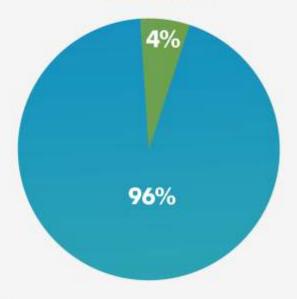
BUYERS EXTREMELY SATISFIED WITH VAST RANGE OF PRODUCTS AND TECHNOLOGIES ON SHOWCASE!

VISITORS LEVEL OF SATISFACTION



Most of the visitors were satisfied with their visit PackPlus 2019. They feel their objective for coming to PackPlus is fulfilled.

VISITORS LIKELINESS TO ATTEND IN 2020



Almost all the visitor have shown interest to attend the next edition of PackPlus in 2020.

INDUSTRY SPEAKS

Nitin Garg NBG Printograph



This is our 5th edition, we have seen the show grow form day one & I think has come a long way. We will be happy to participate in show in future also.

Neerav Parik Line 0 Matic



We are participating for the first time in PackPlus, so we have very good visitors for our shrink rapping SWM50 machine & we are happy with Reed Exhibitions who has arranged this exhibition.

Saurabh Saxena Flexituff Ventures Pvt Ltd



PackPlus is a platform to display & gave importance to our product in the market. We appreciate initiative taken by the PackPlus for last so many years & they are also coming with the novel ideas. I think we both can work forward for a longer period of time.

S K Shukla A V Engineers



Our experience with PackPlus is very good. We are participating in this exhibition from last 5 to 6 years, it's a great pleasure to explore products in this exhibition because we are getting a lot of customers from different segments. Looking forward to continue this participation in future also.

Rakesh Sood Allespack Systems Pvt Ltd



We are very pleased to the response we have received in the PackPlus. We have been participating from last 4 – 5 Years, we did not expect so many footfalls actually. We are thrilled with the response & lot of people appreciated the system which we have displayed. We thank PackPlus for providing us this opportunity & we will be participating in next year also.

Aureal Wei Guangdong LiShunYuan Machinery



This is the second time I am in India for PackPlus. PackPlus now every year giving different experience to our major customers. This time many customers & also lot of companies they come from China here. I am sure in coming days PackPlus will be the 2nd largest show in India, I am hoping exhibition will be great success.

VISITORS PRAISING PACKPLUS

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The exhibition has wide range of products on display we were looking for. We could experience the new to market technologies covering complete solutions for packaging.

Saurabh Malhotra,

Essel Polish Company

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I am visiting PackPlus from last 10 years. This is the place where I get to know on the industry updates, new technologies and products coming in the market. Every year the show is improving with more no.of displays. This year too I could see the difference in arangements for ease of visitors."

Subhash Prajapati Parle Biscuits Pvt Ltd, Neemrana

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OUR ESTEEMED EXHIBITORS









































NETWORKING & KNOWLEDGE EXCHANGE FORUM: THE INTERNATIONAL PACKAGING CONCLAVE

The eighth edition of International Packaging Conclave was held concurrently with PackPlus 2019, in New Delhi on August 30, 2019. The subject of the conclave was 'PAPERING' FOR THE FUTURE OF PACKAGING - Will paper laminate based flexible packaging succeed in replacing flexible plastic packaging?

This conclave aimed to review new developments from the varying perspectives of policy makers, brand owners, raw material manufacturers, convertors as well as EPR Agents













For further details please write to: packplus@reedexpo.co.uk

SEE YOU IN 2020!



ONE BRAND, TWO LOCATIONS!





40% OF LOCATIONS ARE ALREADY SOLD OUT. BOOK NOW TO SECURE PREMIUM SPACE!





CONTACT OUR TEAM

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